

LOCTITE[®] 349[™]

April 2006

PRODUCT DESCRIPTION

LOCTITE® 349™ provides the following product characteristics.

| characteristics. | |
|----------------------|------------------------------------------------------------|
| Technology | Acrylic |
| Chemical Type | Modified methacrylate ester |
| Appearance (uncured) | Transparent colorless to pale yellow liquid ^{LMS} |
| Components | One component - requires no mixing |
| Viscosity | Medium |
| Cure | Ultraviolet (UV) light |
| Application | Bonding |

LOCTITE[®] 349[™] bonds and seals glass to glass, or glass to metal components such as precision optical instruments, furniture and industrial devices. The electrical properties of this product also make it suitable for potting and tacking applications.

TYPICAL PROPERTIES OF UNCURED MATERIAL

| Specific Gravity @ 25 °C | 1.02 |
|-------------------------------------------------|--------------------------------|
| Viscosity, Brookfield - RVT, 25 °C, mPa·s (cP): | |
| Spindle 5, speed 20 rpm | 6,000 to 13,500 ^{LMS} |
| Flash Point - See MSDS | |

TYPICAL CURING PERFORMANCE

This product is cured when exposed to UV radiation of 365nm. To obtain a full cure on surfaces exposed to air radiation at 250nm is also required. The speed of cure will depend on the UV intensity as measured at the product surface. Typical cure condition is 20-30 seconds at 100mW/cm² using a medium pressure, quartz envelope, mercury vapor lamp.

Fixture Time

UV fixture time is defined as the light exposure time required to develop a shear strength of 0.1 N/mm².

UV Fixture Time, Glass, seconds:

| Medium pressure mercury arc: | |
|--------------------------------------------|--------|
| 10 mW/cm ² , measured @ 365 nm | 3 to 8 |
| 100 mW/cm ² , measured @ 365 nm | 1 to 5 |

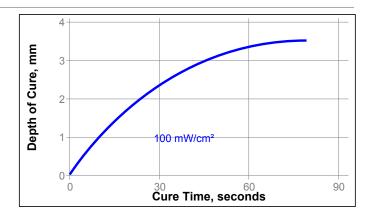
Tack Free Time

Tack Free Time is the time required to achieve a tack free surface.

| Tack Free Time, seconds: | |
|--------------------------------------------|---------|
| Medium pressure mercury arc: | |
| 100 mW/cm ² , measured @ 365 nm | 5 to 10 |

Depth of Cure

The graph below shows the increase in depth of cure with time at 100mW/cm² as measured from the thickness of the cured pellet formed in a 15mm diameter PTFE die.



TYPICAL PROPERTIES OF CURED MATERIAL **Physical Properties**

| Thysical Troperties | |
|----------------------------------------------------------------|---------------------|
| Coefficient of Thermal Expansion, ISO 11359-2, K ⁻¹ | 80×10 ⁻⁶ |
| Coefficient of Thermal Conductivity, ISO 8302, W/(m·K) | 0.1 |
| Specific Heat, kJ/(kg·K) | 0.3 |
| Shore Hardness, ISO 868, Durometer D | 70 |
| Electrical Properties | |
| Volume Resistivity, IEC 60093, Ω·cm | 5×1015 |
| Dielectric Breakdown Strength, IEC 60243-1, kV/mm | 90 |
| Dielectric Constant / Dissipation Factor, IEC 60250: | |

1 kHz 3.55 / 0.025 TYPICAL PERFORMANCE OF CURED MATERIAL

Adhesive Properties

| Cured @ 100 mW/cm ² , measured @ 365 nm fo Tensile Strength, ISO 6922: | r 40 seco | nds |
|--------------------------------------------------------------------------------------|-----------------|------------------------------|
| Steel pin (grit blasted) to Glass | N/mm² | 11 |
| | (psi) | (1,600) |
| Cured @ 100 mW/cm ² , measured @ 365 nm 24 hours post cure @ 22 °C | for 10 se | econds plus |
| Torsional Shear Strength, ASTM D 3658: | | |
| Aluminum hex button to Glass | N∙m (lb.in.) | ≥70 ^{∟мs} (≥620) |

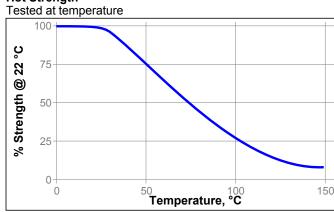
TYPICAL ENVIRONMENTAL RESISTANCE

Cured @ 100 mW/cm², measured @ 365 nm for 40 seconds plus 1 week @ 22 °C

Tensile Strength, ISO 6922: Steel pin (grit blasted) to Glass

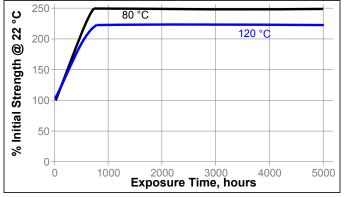


Hot Strength



Heat Aging





Chemical/Solvent Resistance

Aged under conditions indicated and tested @ 22 °C.

| | | % of initial strength | | |
|-------------------------------|----|-----------------------|-------|--------|
| Environment | °C | 100 h | 500 h | 1000 h |
| Gasoline | 22 | 100 | 100 | 100 |
| Freon TA | 22 | 100 | 100 | 100 |
| Industrial methylated spirits | 22 | 100 | 100 | 100 |
| Heat/humidity 90% RH | 40 | 100 | 100 | 70 |

GENERAL INFORMATION

This product is not recommended for use in pure oxygen and/or oxygen rich systems and should not be selected as a sealant for chlorine or other strong oxidizing materials.

For safe handling information on this product, consult the Material Safety Data Sheet (MSDS).

Directions for use

- 1. This product is light sensitive; exposure to daylight, UV light and artificial lighting should be kept to a minimum during storage and handling.
- 2. The product should be dispensed from applicators with black feedlines.
- 3. For best performance bond surfaces should be clean and free from grease.
- 4. Cure rate is dependent on lamp intensity, distance from light source, depth of cure needed or bondline gap and light transmittance of the substrate through which the radiation must pass.
- 5. Recommended intensity for cure in bondline situation is 40 mW/cm² minimum (measured at the bondline) with an exposure time of 4-5 times the fixture time at the same intensity.
- For dry curing of exposed surfaces, higher intensity UV is required (100 mW/cm²).
- 7. Cooling should be provided for temperature sensitive substrates such as thermoplastics.
- 8. Plastic grades should be checked for risk of stress cracking when exposed to liquid adhesive.
- 9. Excess adhesive can be wiped away with organic solvent.
- 10. Bonds should be allowed to cool before subjecting to any service loads.

Loctite Material Specification^{LMS}

LMS dated September 1, 1995. Test reports for each batch are available for the indicated properties. LMS test reports include selected QC test parameters considered appropriate to specifications for customer use. Additionally, comprehensive controls are in place to assure product quality and consistency. Special customer specification requirements may be coordinated through Henkel Quality.

Storage

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: 8 °C to 21 °C. Storage below 8 °C or greater than 28 °C can adversely affect product properties. Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Conversions

 $(^{\circ}C \ge 1.8) + 32 = ^{\circ}F$ kV/mm $\ge 25.4 =$ V/mil mm / 25.4 = inches μ m / 25.4 = mil N $\ge 0.225 =$ lb N/mm $\ge 5.71 =$ lb/in N/mm² $\ge 145 =$ psi MPa $\ge 145 =$ psi MPa $\ge 145 =$ psi N·m $\ge 8.851 =$ lb·in N·m $\ge 0.738 =$ lb·ft N·mm $\ge 0.142 =$ oz·in mPa·s = cP

Note

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Reference 1.1